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2013年7月

FT8010 延迟时间可配置的复位定时器

特性

- 长延迟可配置为7.5或11.25秒
- 初级和次级输入重置引脚
- 推挽和开路漏极输出引脚
- 1.8 工作范围为V至5.0 V(T_A=-40°C至+85°C)
- 1.7 工作范围为V至5.0 V(T_A=-25°C至+85°C)
- 1.65 工作范围为V至5.0 V (T_A=0°C至+85°C)
- 提供10引脚UMLP (1.4 mm x 1.8 mm)封装和8引脚MLP (2.0 mm x 2.0 mm)封装

说明

FT8010是定时器,用于复位那些复位时间较长的移动设备。长时延迟可避免因意外按键所引起的非预期复位。可以通过硬接线 DSR引脚选择两种延迟: 7.5 ±20% 秒或11.25 ± 20% 秒。

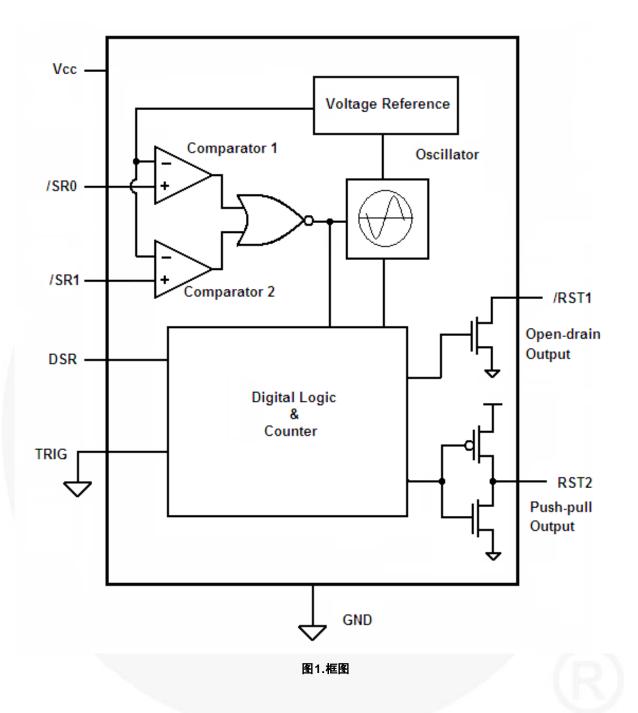
FT8010有两个输入,用于单按钮或双按钮复位功能。该器件有两个输出: 0.5 mA驱动的推挽式输出和0.5 mA下拉驱动的漏极开路输出。

FT8010不工作时消耗的 I_∞ 电流最少,它可在1.65 V至5.0 V宽电源电压范围内工作

订购信息

器件编号	工作温度范围	封装	包装方法
FT8010UMX	-40°C 至 +85°C	10引脚超薄MLP(1.4 x 1.8 x 0.55 mm封装, 0.40 mm间距)	每卷5000装卷 带和卷盘
FT8010MPX	-40°C 至 +85°C	8引脚MLP(2.0 x 2.0 x 0.8 mm封装, 0.5 mm间 距)	每卷3000装 卷带和卷盘





引脚布局

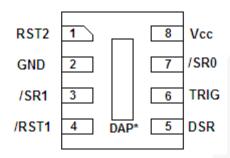


图2.MLP引脚配置⁽¹⁾ (俯视图)

GND 1 7 /SR0 /SR1 2 6 TRIG 3 4 5 /RST1 NC DSR

图3.UMLP引脚配置^②

(俯视图)

RST2 NC Vcc

注意:

- 1. DAP可以不接,或连接至地。
- 2. NC =不接线。

引脚说明

MLP引脚编号	UMLP引脚编号	名称	说明
1	10	RST2	推挽式输出,有源高电平
2	1	GND	接地
3	2	/SR1	次级重置输入,有源低电平
4	3	/RST1	漏极开路输出,低电平有效
5	5	DSR	延迟选择输入(必须直接连接至GND或V _∞ ; 不使用上拉或下拉电阻)
6	6	TRIG	测试引脚,在正常使用时连接至GND
7	7	/SR0	初级重置输入,有源低电平
8	8	V _{cc}	电源
	4, 9,	NC	未连接

功能说明

FT8010复位定时器包含了一个内部振荡器和一个两级、21位计数器,用于确定输出引脚转换的时间。借助DSR引脚的硬连接逻辑电平,可以设置时间N。当DSR为低时,N 为 $7.5 \text{ s}\pm20\%$,当DSR为高时,N 为 $11.25 \text{ s}\pm20\%$ 。

Table 1. FT8010 真值表

DSR	复位定时器(+-20%)		
0	7.50 s		
1	11. 25 s		

输入引脚/SR0和/SR1用来驱动电压比较器,比较电压为输入电压和由参考模块设置的电压。/SR0和/SR1的输入信号同时为低时,振荡器启动。振荡器向数字芯片发送数字脉冲,其中包括计数器。有两种计数情景,如下所述: 短时持续和长时持续。对于短时持续情况,/RST1 和RST2引脚不受影响。长时持续情况下,输出在时间N后更改状态。/SR0或/SR1的输入信号为高时,输出返回至其原始状态

/RST1输出为一个开漏驱动器。当计数时间超过时间N后,/RST1输出驱动为低。/RST2输出为一个推挽驱动器。当计数时间超过时间N后,RST2输出驱动为高。

正常使用时,TRIG引脚应该连接到地(GND)或低电平。TRIG引脚为测试模式引脚,用于扫描(SCAN)测试。

应用指南

重要声明: DSR引脚必须连接至 V_{oo} 或GND,以提供高或低电压电平。DSR引脚的电压电平决定可配置延迟的时间长度。需要指出的是,在正常工作中,DSR引脚的电压电平维持不变。DSR引脚必须在SRO或SR1按键变低之前直接连接至 V_{oo} 或GND。请勿在DSR引脚上使用上拉或下拉电阻。

短时持续(tw < N)

在这种情况下,输入/SR0和/SR1在比时间N短的持续时间tw 均为低电平。当输入变为低电平时,内部定时器开始计数。输入在时间N前变为高电平。定时器停止计数并复位,并且输出无变化(参见图4)。

/SR0	/SR1	/RST1	/RST2	说明
∇	L	Н	L	当两个引脚均低时,定时器开始计数。当任意一个引脚变高时,定时器停止
L	7	Н	L	计数。/SRO 和/SR1都需要变低时,才能激活(启动)定时器。

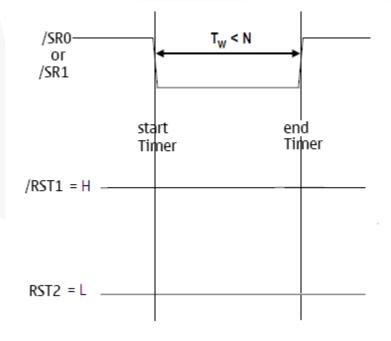


图4.短时持续波形

长时持续(t_w > N)

在这种情况下,输入/SR0和/SR1在比时间N长的持续时间t_{*}均为低电平。当输入变为低电平时,内部定时器开始计数。在时间N之后,各输出转换,定时器停止计数。N秒后的某个时刻,该输入变高。当输入变为高电平

时,一段传播延迟后,定时器复位,各输出切换回各自的原始状态*(参见图5)*。

/SR0	/SR1	/RST1	RST2	说明
∇	L	>	₹	当两个引脚均低时,定时器开始计数。时间N后,各输出转换。当任意 一个输入变高时,定时器复位,各输出转换回到原始状态。/SRO 和
L			$\overline{}$	/SR1都需要变低时,才能激活(启动)定时器。

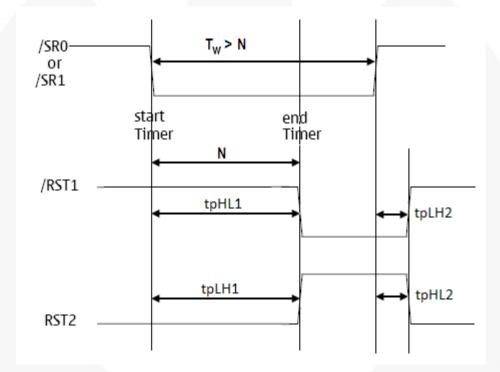


图5.长时持续波形

注意:

3. 波形绘制没有按照比例(tpHL1, tpLH1 >> tpHL2, tpLH2)。

绝对最大额定值

应力超过绝对最大额定值,可能会损坏设备。在超出推荐的工作条件的情况下,该器件可能无法正常运行或操作,且不 建议让器件在这些条件下长期工作。此外,过度暴露在高于推荐的工作条件下,会影响器件的可靠性。绝对最大额定值 仅是额定应力值。

符号	参数	条件	最小值	最大值	单位
V _{cc}	电源电压		-0. 5	7	٧
V _{IN}	DC输入电压	/SRO, /SR1, TRIG, DSR	-0.5	7	٧
		/RST1高电平或低电平	-0.5	7	
V_{out}	V _{out} 输出电压 ['] 4 [']	RST2高电平或低电平	-0.5	Vcc+0. 5	٧
		/RST1, RST2, V _{cc} =0	-0. 5	7	
Lik	直流输入二极管电流	V _{IN} < 0 V		-50	mA
	I _{ok} DC输出二极管电流	V _{out} < 0 V		-50	mA
I ok	100制山—1次旨屯加	$V_{\text{out}} > V_{\text{cc}}$		+50	
I _{OH} /I _{OL}	DC输出源/灌电流		-50	+50	mA
I _{cc}	每个电源引脚的DC V∞或接地电流			±100	mA
T _{STG}	存储温度范围		-65	+150	°C
TJ	偏压下结温		\ \	+150	°C
TL	结点焊接温度,焊接10秒			+260	°C
P _D	功耗			5	mW
ESD	静电放电能力	人体模式, JESD22-A114		4	L/
LSD		充电器件模式, JESD22-C101		2	kV

注意:

4. 必须注意1。绝对最大额定值。

推荐工作条件

推荐的操作条件表定义了器件的真实工作条件。指定推荐的工作条件,以确保设备的最佳性能达到数据表中的规格。飞兆半导体建议不要超过推荐工作条件,也不能按照绝对最大额定值进行设计。

符号	参数	条件	最小值	最大值	单位
		-400° 至+850°	1. 8	5. 0	
V _{cc}	电源电压	-25C° 至+85C°	1. 7	5. 0	٧
		OC°至+85C°	1. 65	5. 00	
t _{RFC}	断电后, V∞ 恢复时间	V∞=0 V断电后,上升至0.5 V	5		ms
V _{IN}	输入电压	/SR0, /SR1	0	5	٧
		/RST1高电平或低电平	0	5	
V _{out}	输出电压	RST2高电平或低电平	0	V _{cc}	٧
1		/RST1、RST2、Vcc=0 V	0	5	
I _{OH}	DC输出源电流	RST2, 1.8 V \leq V _{CC} \leq 3.0 V	\	-0.1	
I OH	DOTHILL II II II II II II II	RST2, 3.0 V \leq V _{CC} \leq 5.0 V		-0.5	mA
I _{OL}	DC输出灌电流	/RST1, RST2, V _∞ =1.8 V to 5.0 V		+0.5	
TA	空气流通时的工作温度		-40	+85	°C
Θ_{JA}	热阻	MLP-8		245	° C/W
OJA	WALT	UMLP-10		200	0/11

注意:

5. 所有未用的输入端必须保持为V∞ 或GND。

直流电气特性

除非另行说明,以下性能特性需满足条件: $T_A=-40$ 至800且 $V_{cc}=1.8-5.0V$ 或 $T_A=-25$ 至850且 $V_{cc}=1.7-5$ V或 $T_A=0$ 至850且 $V_{cc}=1.65-5$ V。

符号	参数	条件	最小值	最大值	单位
V _{IH}	输入高电平	/SR0, /SR1	1. 2		V
V IH	棚八同电十	DSR	0.65 x V _{cc}		V
V _{IL}	输入低电平	/SR0, /SR1		0. 32	V
V IL	- 柳八似电十	DSR		0. 25 x V _{cc}	
		RST2, Ι _{οΗ} =-100 μA	0.8 x V _{cc}		
V_{OH}	V₀н 高电平输出电压	RST2、I _{0H} =-500 μA V _{0C} =3.0至5.0 V	0.8 x V _{cc}	1	٧
Vol	低电平输出电压	RST2, Ι _α =500 μA		0. 3	V
V 0L		/RST1, Ι _{οι} =500 μA		0. 3	٧
Lin	输入漏电流	$0 V \leq V_{IN} \leq 5.0 V$		±1.0	μА
	静态电源电流 (定时器关闭)	/SRO or /SR1=V₀₀		20	11.Λ
I _{cc}	动态电源电流 (定时器运行)	/SR0=/SR1=0 V		100	μ A

交流电气特性

除非另行说明,以下性能特性需满足条件: $T_A=-40$ 至80C且 $V_{\infty}=1.8-5.0$ $V_{\underline{o}}$ $T_A=-25$ 至85C且 $V_{\infty}=1.7-5$ $V_{\underline{o}}$ $T_A=0$ 至85C且 $V_{\infty}=1.65-5$ $V_{\infty}=1.65$

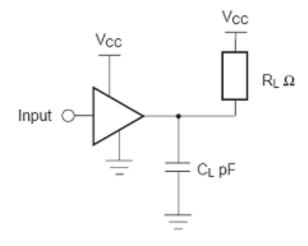
符号	参数	工作条件	最小值	典型值	最大值	单位
+	定时器延迟,/SRn至/RST1, (DSR=0)	C _L =5 pF, R _L =5 kΩ 参见图6	6. 0	7. 5	9. 0	s
t _{PHL1}	定时器延迟,/SRn至/RST1, (DSR=1)	C _L =5 pF, R _L =5 kΩ 参见图6	9. 00	11. 25	13. 50	s
t _{PLH2}	传播延迟,/SRn至/RST1, (DSR=0或1)	C _L =5 pF, R _L =5 kΩ 参见图6		220	310	ns
t _{PLH1}	定时器延迟,/SRn至/RST2, (DSR=0)	C _L =5 pF, R _L =10 kΩ 参见图7	6. 0	7. 5	9. 0	s
SPLH1	定时器延迟,/SRn至/RST2, (DSR=1)	C _L =5 pF, R _L =10 kΩ 参见图7	9. 00	11. 25	13. 50	s
t _{PHL2}	传播延迟,/SRn至/RST2, (DSR=0或1)	C _L =5 pF, R _L =10 kΩ 参见图7		210	300	ns

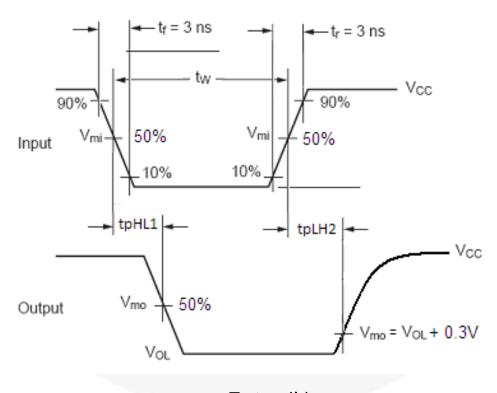
电容规格

T_A=+25°C.

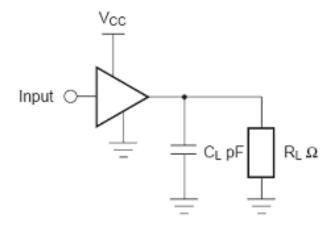
符号	参数	工作条件	典型值	单位
CIN	输入电容	V _{cc} =GND	4. 0	pF
C _{OUT}	输出电容	V _{cc} =5. 0 V	5. 0	pF

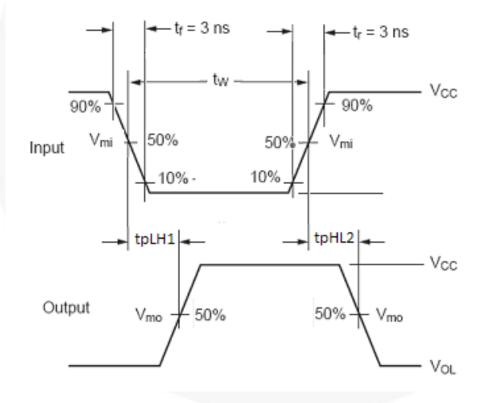
交流测试电路与波形





交流测试电路和波形 (续)





物理尺寸测试

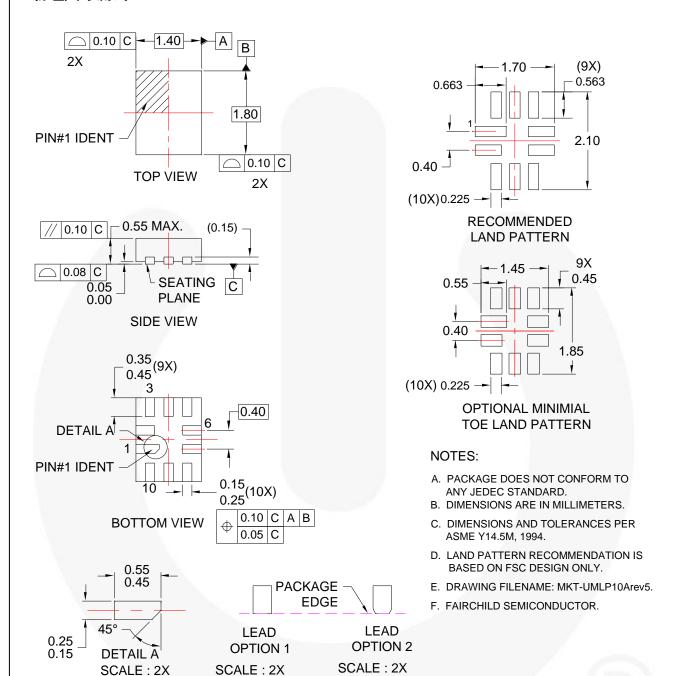
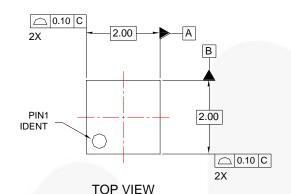


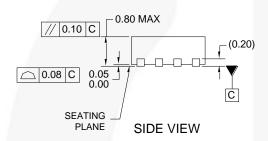
图8.10引脚超薄MLP, 1.4 x 1.8 x 0.55 mm封装

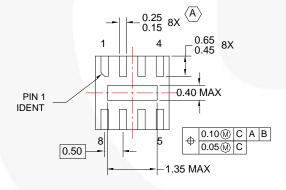
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物理尺寸(续)







BOTTOM VIEW

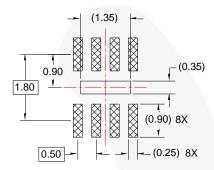
TOP LAYER CU KEEP OUT AREA

1.80

(0.90) 8X

(0.50) - - - (0.25) 8X

OPTION #1: NO CENTER PAD



OPTION #2: WITH CENTER PAD

RECOMMENDED LAND PATTERN (NSMD PAD TYPE)

NOTES:

- (A.) PACKAGE CONFORMS TO JEDEC MO-229, VARIATION W2020D EXCEPT WHERE NOTED.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
- D. LAND PATTERN RECOMMENDATION BASED ON PCB MATRIX CALCULATOR V2009.
- E IF CENTER PAD IS NOT SOLDERED TO, NO EXPOSED METAL IS ALLOWED IN THE TOP LAYER OF THE BOARD IN THE AREA SHOWN.
- F. DRAWING FILENAME: MKT-MLP08Rrev2.

图9.8引脚模塑无铅封装(MLP), 2.0 x 2.0 x 0.8 mm

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Definition of Terms

Datasheet Identification	Product Status	Definition
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